

Product Index / Nomenklatur

Here you can find the list of all available product categories for SEMICON Europa / electronica 2026. Please provide us with the names and numbers of the categories that you want to book. **Categories highlighted in blue cannot be selected as they are headings!**

5 entries in the product and service directory are already included in your basic entry. Each additional entry costs EUR 90 (from 10 additional entries EUR 85 each, from 20 additional entries EUR 80 each, from 30 additional entries EUR 75 each).

You can book an unlimited number of product categories with a **flat rate** for EUR 2,990.

If you want to add your logo to your entries, you can do so by booking the **logo in all directories** for EUR 475.

Hier finden Sie die Liste aller für die SEMICON Europa / electronica 2026 verfügbaren Produktkategorien. Nennen Sie uns für die Buchung die entsprechenden Nummern und Bezeichnungen.

Überkategorien (blau hinterlegt) sind nicht buchbar!

5 Einträge sind im Grundeintrag enthalten. Jeder weitere Eintrag kostet 90 EUR (ab 10 zusätzlichen Einträgen je 85 EUR, ab 20 zusätzlichen Einträgen je 80 EUR, ab 30 zusätzlichen Einträgen je 75 EUR).

Mit der **Flatrate** für 2.990 EUR können Sie eine unbegrenzte Anzahl an Produktkategorien buchen.

Wenn Sie Ihr Logo hinzufügen möchten, buchen Sie das **Logo in allen Verzeichnissen** für 475 EUR.

16.01	Photovoltaic Device Manufacturing
16.01.01	PV: Cells
16.01.02	PV: Modules
16.01.03	PV: Stand-Alone Systems
16.01.04	PV-Building-Integrated Solutions
16.01.05	Solar Thermal
16.02	Packaging and Assembly Equipment
16.02.01	Backgrind; Slicing; Lapping; Polishing Equipment
16.02.02	Ball Placement; Attach Systems
16.02.03	Base Loader Systems
16.02.04	Cleaning; Washing Equipment for Assembly & Packaging
16.02.05	Cut & Down Set; Trim; Form Equipment
16.02.06	Deflashing; Degating Tools
16.02.07	Device Handling; Feeding Systems
16.02.08	Dicing; Sawing; Scribing; Separation Equipment
16.02.09	Die Bonding; Attach Equipment
16.02.10	Die Removal Equipment
16.02.11	Die Sorter; Pick & Place; Flip Chip Placement Systems
16.02.12	Dispensing Systems
16.02.13	Hot Embossing System
16.02.14	Lead Finishing; Straightening Equipment
16.02.15	Lead Frame Taping Systems
16.02.16	Lithography Systems for Wafer Level Packaging; Bumping; 3D Interconnect Aligners
16.02.17	Marking; Imprinting; Labeling Equipment
16.02.18	Molding; Encapsulation; Decapsulation Equipment
16.02.19	Package Handling; Conveying Equipment
16.02.20	Package Simulation; Characterization Equipment
16.02.21	Plating; Electro Chemical Plating for device assembly
16.02.22	Printed and Organic Electronic Equipment
16.02.23	Solder Reflow; Soldering & Brazing Equipment
16.02.24	Wafer Level Bonders

16.02.25	Wafer Mount; Taping Equipment
16.02.26	Wire Bonding Equipment
16.03	Flat Panel Display Equipment
16.03.01	Alignment Film Coating Equipment
16.03.02	Anodic Oxidation Equipment
16.03.03	Color Pattern Processing Equipment
16.03.04	Laser Treatment; Cutting Systems for Panels & Photocells
16.03.05	Liquid Crystal Injection or Filling Equipment
16.03.06	Low Pressure Plasma Spray (LPPS) Equipment
16.03.07	Luminous Layer Patterning and Sealing Equipment
16.03.08	Panel Alignment; Cell Assembly Equipment
16.03.09	Polarizer Sticking Equipment
16.03.10	Scribe and Break Equipment
16.03.11	Seal Patterning Equipment
16.03.12	Spacer Spraying Equipment
16.04	Other Equipment
16.04.01	Cutting; Drilling; Laser ablation; Beveling Equipment
16.04.02	Heating; Annealing; Curing Equipment - Furnaces; Conveyors; Ovens; Test Chambers; Heat Treating
16.04.03	Lamination; Sheet Laminating Equipment
16.04.04	Repair; Rework Equipment
16.04.05	Sealing; Bagging; Packing Equipment
16.04.06	Space simulation; Vacuum chambers
16.04.07	Vacuum drying & out gassing Systems
16.04.08	Vibration Isolation Systems
16.04.09	Vision; ID; Bar Code Systems
16.04.10	Welding Equipment
16.05	Inspection & Measurement Products
16.05.01	Air Velocity (VA) Humidity and Moisture Sensing
16.05.02	Centrifuges
16.05.03	Chromatograph
16.05.04	CV (capacitance-to-voltage) Probe systems

16.05.05	Defect; Particle; Bump; Contamination Detection, Review or Inspection
16.05.06	Die Inspection; Die Shear
16.05.07	ESCA; Ultrasonic; Acoustical Microscopes
16.05.08	Fiber Optic Inspection Instruments
16.05.09	Film Thickness; Thickness; Uniformity Measurement; Ellipsometer
16.05.10	Flat; Notch Finding System
16.05.11	Instruments; Bench Top Test
16.05.12	Leak Detection Systems - Vacuum or Gas
16.05.13	Line Width; Critical Dimension (CD) Measurement
16.05.14	Microscopes: Atomic Force Microscopes (AFM)
16.05.15	Microscopes: Confocal Scanning Microscope; 3-D Video Microscopes
16.05.16	Microscopes: Optical Microscopes
16.05.17	Microscopes: SEM; Focused Ion Beam (FIB), TEM
16.05.18	Overlay Measurement
16.05.19	Package Inspection; Lead Scanners
16.05.20	Particle Monitors; Analyzers - Airborne or Liquid
16.05.21	Plate Inspection Equipment
16.05.22	Resistivity Measurement; 4 point probe; Sheet resistance
16.05.23	Spectrometers; FTIR; ATR-FTIR; Auger Electron (AES); SIMS
16.05.24	Stress; Refractive Index; Reflectivity & Conductivity Measurement
16.05.25	Thermal Sensing, Measurement, Analysis
16.05.26	Wafer; Substrate Metrology; Topology; Nanotopography; Flatness Measurement; Crystalline Orientation
16.05.27	Weight measurement; precision scales
16.05.28	Wire Bonding Inspection; Test
16.05.29	X-ray; XRF; 3-D X-Ray; LEXES Systems
16.06	MEMS Equipment
16.06.01	Deep RIE etching; Dry Etching
16.06.02	Double sided mask aligner
16.06.03	Wafer Level Bonders
16.07	Nanotechnology Equipment and Tools
16.07.01	Equipment, Nanotechnology Tools
16.08	PV Equipment
16.08.01	Cells
16.08.02	Inspection and Metrology
16.08.03	Integration and Automation
16.08.04	Modules
16.08.05	Other
16.08.06	Thin Film
16.08.07	Wafers
16.09	Process Equipment
16.09.01	Bumping Systems
16.09.02	Chemical Mechanical Polishing (CMP); Electro Polishing, Mechanical Polishing Equipment
16.09.03	Cleaning; Washing; Drying Equipment for Substrate, Fab Processing
16.09.04	Coat; Develop; Resist Processing; Track Equipment
16.09.05	Crystal Growing & Machining Equipment
16.09.06	Deposition; Chemical Vapor (CVD); MOCVD; PECVD; LPCVD; ALD; REALD; MVD
16.09.07	Deposition; Physical Vapor (PVD); Sputtering; Evaporation Equipment
16.09.08	Environmental Enclosures; Minienvironments
16.09.09	Epitaxy Equipment; Epi Reactors; Molecular Beam Epitaxy (MBE); Atomic Layer Epitaxy (ALE)
16.09.10	Etching; Stripping; Ashing - Dry and Wet Equipment
16.09.11	Ion Implantation Equipment

16.09.12	Ion; E-Beam Milling Etching Equipment
16.09.13	Lithography; Exposure; Aligners; Direct Write Systems; Steppers; Scanners; Nanoimprint
16.09.14	Plating; Electro Chemical Plating; Deposition Systems
16.09.15	SOI Bonders; Temporary Bonders; De-Bonders
16.09.16	Spin on Glass (SOG); on Dielectric (SOD) Track systems
16.09.17	Thermal Processing - Diffusion; Oxidation; Annealing; RTA; RTP Equipment
16.09.18	Transfer Systems for Wafer; Reticles or FPD's
16.09.19	Wafer Identification; Marking Equipment
16.10	Test Equipment
16.10.01	Burn-In Accessory Systems
16.10.02	Burn-In Systems
16.10.03	Circuit Repair; Design Modification; Redundant Memory Repair; Mask Repair Systems
16.10.04	Discrete Component Test Systems
16.10.05	Environmental Stress Systems - Temperature; Humidity; Pressure; HAST
16.10.06	ESD; EMS and Latch-up Systems
16.10.07	Failure Analysis Systems
16.10.08	FPD Test; Measurement; Repair Equipment
16.10.09	Functional Test Systems
16.10.10	Handlers; Positioner Systems
16.10.11	Linear Test Systems
16.10.12	Logic Test Systems
16.10.13	Memory Test Systems
16.10.14	Optical Test Systems
16.10.15	Package Test Systems
16.10.16	Parametric Test Systems
16.10.17	Printed Circuit Board; Wire Board (PCB or PWB) Test and Repair
16.10.18	Probe Card Maintenance and Analysis Systems
16.10.19	Probing Equipment incl. Analytical; Circuit; Manual; E-Beam; Optical; Wafer Probers
16.10.20	System on a Chip (SOC); Mixed Signal Test Systems
16.10.21	Test Contactor Cleaning; Conditioning Systems
16.10.22	Test Head Manipulators and Docking Stations
16.10.23	Wireless, non-contact Test Systems
16.11	Packaging and Assembly Materials
16.11.01	Adhesives; Epoxies; Die Attach Compounds; Under fill Materials; Conductive & Non-Conductive
16.11.02	Bonding; Interconnect Materials - Wire; Ribbon; Tape; Capillaries & Tools
16.11.03	Lead Frames & Headers: Etched; Stamped
16.11.04	Molding; Encapsulation; Potting; Resin Materials
16.11.05	Package Substrates; Laminate; Film based
16.11.06	Packages; Ceramic and Other High Temp Compounds
16.11.07	Packages; Plastic
16.11.08	Preforms; Lids
16.11.09	Printed Circuit Boards (PCB); Printed Wire Boards (PWB)
16.11.10	Printing Masks; Screens
16.11.11	Scribe Tools; Saw or Dicing Blades and Accessories
16.11.12	Solder; Solder Balls and other Soldering Materials
16.11.13	Thermal Interface Materials; Heat Sinks
16.11.14	Thick Film Pastes; Materials
16.11.15	Thin Film; Dielectric Film Materials
16.12	Chemicals & Solids
16.12.01	Acids; Etchants
16.12.02	Buffers; Alkalis; Bases
16.12.03	Cleaning Chemicals; Solvents; Strippers
16.12.04	DI; UP Water

16.12.05	Dopants; liquid or solid
16.12.06	Other Specialty Chemicals
16.12.07	Photo Resist; Developers & Ancillaries (incl. Adhesion promoter (HMDS); Primer; Anti-Reflective Coat
16.12.08	Solids
16.12.09	Spin on glass material
16.12.10	Surface protection material; coatings
16.13	FPD Materials
16.13.01	Alignment Film Materials
16.13.02	Color Filter Materials
16.13.03	End-Sealing Material
16.13.04	Glass Plates for FPD
16.13.05	Liquid Crystal Materials
16.13.06	Polarizer Materials
16.13.07	Spacer Materials
16.14	Gases
16.14.01	Analytical Instrumentation Mixtures
16.14.02	Dopant Gases
16.14.03	Environmental Compliance Mixtures
16.14.04	Etchant Gases
16.14.05	Fuel Gases
16.14.06	Laser Gas Mixtures
16.14.07	Other Specialty; Mixed Gas
16.14.08	Pure & Bulk Gases
16.14.09	Rare; Noble Gases
16.14.10	Reactant Gases
16.14.11	Silicon Precursor Gas
16.15	Mask Making Materials
16.15.01	Mask and Reticle Handling Products
16.15.02	Mask plate blanks; Glass
16.15.03	Pellicles; Mounting Fixtures
16.15.04	Plate or Pellicle Repair & Materials
16.15.05	Transfer lithography masks; Polymer masks; templates (for Nanoimprint)
16.16	Nanotechnology Materials
16.16.01	Nanotechnology Materials
16.17	PV Materials
16.17.01	Consumables
16.17.02	Feedstock: Polysilicon, UMG, etc.
16.17.03	Gases and Liquid Chemicals
16.17.04	Ingots, Wafers
16.17.05	Other
16.17.06	Solar Glass, encapsulation
16.18	Process Materials
16.18.01	CMP; Grind; Lap; Polish; Abrasive materials
16.18.02	Deposition Supplies
16.18.03	Deposition/Target Materials
16.18.04	Ingots
16.18.05	Photo Masks; Finished or Patterned
16.18.06	Plasma; Ion Sources
16.18.07	Plating Materials
16.18.08	Polysilicon or granular polycrystalline silicon; Crystal growing Material
16.18.09	Process Chamber Components; Graphite; Carbon Fiber Carbon (CFC); Pyrolytic Boron Nitride (PBN)
16.18.10	Quartzware (Silicon Carbide, Fused Quartz Glass, Sapphire), Ceramic & Oxide Ceramic Fixtures
16.19	Substrates
16.19.01	Compound Semiconductor substrates (GaAs on Silicon; GaN; InP; SiGe, etc.)
16.19.02	Diamond substrates

16.19.03	Epitaxial; Epi; Gettered; Internal Gettered Wafers
16.19.04	Gallium Arsenide (GaAs); Sapphire Substrates
16.19.05	Prime; Polished; Mirrored Wafers
16.19.06	Silicon on Insulator (SOI); Silicon on Sapphire (SOS); Silicon Carbide;
16.19.07	solar cell substrates; crystalline silicon (c-Si); thin film
16.19.08	Strained silicon; Engineered Substrates
16.19.09	Test; Monitor Wafers; Reclaim or Virgin
16.19.10	Thin & Thick film substrates for MEMS
16.20	Test Materials
16.20.01	Burn-In Boards; Performance Boards (incl. Low; High Temp and Ceramic)
16.20.02	Probe Cards; DUT boards and other probing accessories (incl Ceramic and Special Purpose Probe Cards)
16.20.03	Structural Circuits; Test; Thermal Fixturing
16.20.04	Test Sockets; Contactors and Contact accessories
16.21	Components, Parts & Accessories
16.21.01	Bearings; Shaft Collars
16.21.02	Chucks for Wafer and other Substrates
16.21.03	Computer Accessories; Peripherals; Upgrades; Service
16.21.04	Connectors; Plugs; Interconnects; Cable; Wire
16.21.05	Electronic Hardware; Fixtures and Supplies
16.21.06	Enclosures; Cabinets
16.21.07	Fasteners; General Hardware
16.21.08	Filters for Liquid; Oil
16.21.09	Filters, Getters, Purifiers, Catalysts for Gases
16.21.10	Flow Control Components - Valves; Meters; Gauges; Regulators; MFC's
16.21.11	Gaskets; Seals; O rings; Elastomers; Resins
16.21.12	Heating elements; coils; insulation; vestibule blocks and other Furnace components
16.21.13	Lamps (non Lithography), all type UV; LED and other
16.21.14	Lamps for Lithography
16.21.15	Magnetic Components; Heads
16.21.16	Motors; Fans; Electric Rotary Spindles
16.21.17	Piezo Electronic Components
16.21.18	Pipe; Tubing; Hose; Flanges; Connectors; Couplings; Plumbing Fittings
16.21.19	Raw Material & Custom components; Metal
16.21.20	Raw Material & Custom components; Plastic
16.21.21	Sealants; Adhesives; Finishes
16.21.22	Sensors
16.21.23	Vacuum Systems Components & Accessories (optical monitors; Sputtering target fixtures; lubricants
16.21.24	Windows
16.22	Sub-systems
16.22.01	Cameras - Still; CCD; Video & Monitors
16.22.02	Computer; Control; Communication; Data Acquisition Systems
16.22.03	Electron tube & Ion Beam Apparatus & Sources
16.22.04	Exposure; Illumination Sources - Laser; Lamp; X-ray & other
16.22.05	Gas; Liquid delivery panels as subsystems
16.22.06	Handling; Transfer; Loading Systems; Lifting devices
16.22.07	Hydraulic Systems
16.22.08	Motion control systems; Servo control systems & Components
16.22.09	Optics; Lens Products; Auto-Focus Systems
16.22.10	Plasma Sources; Controls; Monitoring; Diagnosis
16.22.11	Pneumatic Systems; Pneumatic rotary spindles
16.22.12	Power Supplies; RF Generators; Converters; Electrical Conditioning
16.22.13	Process Monitoring systems

16.22.14	Pumps, for Fluids
16.22.15	Pumps, Vacuum
16.22.16	Temperature Sensing; Control; Recirculators; Chillers; Heat Exchangers
16.22.17	Ultrasonic Generators; Transducer and Monitoring Systems
16.23	PV Systems
16.23.01	Chargers, Batteries
16.23.02	Inverters
16.23.03	Measurement and Control Technology
16.23.04	Stand-Alone Systems
16.24	PV Components, Tracking and Mounting Systems
16.24.01	Cables, Connectors, Junction Boxes
16.24.02	Mounting Systems
16.24.03	Tracking Systems
16.25	Factory Monitoring & Control Systems (FMCS)
16.25.01	Chemical; Pure Water; Fluid Handling; Storage; Supply Systems
16.25.02	Chemical; Pure Water; Fluid Monitoring & Control Systems
16.25.03	Data Collection; Building control systems
16.25.04	Electrical; Power Distribution
16.25.05	Emergency (fire) & Security Control Systems
16.25.06	Environmental; Utility Systems & Monitoring
16.25.07	Equipment Interface; Communication Protocols
16.25.08	Gas and Other Generation Systems
16.25.09	Gas Handling - Cabinets; Control; Supply Systems
16.25.10	Gas Monitoring Equipment; RGA's; TGO compliance
16.25.11	Logistics; Floor Control Systems
16.25.12	Process Controls
16.25.13	Waste Control; Effluent Management Systems (Fluid & Gas; Exhaust Conditioning; Scrubbers)
16.26	HVAC, Temperature, Humidity, Contamination Control
16.26.01	Clean Rooms
16.26.02	Contamination Control; HEPA Filtering Systems
16.26.03	HVAC; Temperature; Humidity Systems and Control
16.27	Material Handling Systems
16.27.01	Conveying; Material Handling Systems
16.27.02	Robotics; Transfer Systems
16.27.03	Static; ESD Control
16.27.04	Stockers; Storage, AMHS
16.28	Communication Software
16.28.01	Equipment Interface; Communication Protocols
16.29	Design Software
16.29.01	CAD - Computer Automated Design
16.29.02	EDA - Electronic Design Automation; Circuit Design
16.30	Manufacturing Software
16.30.01	CAM or CIM - Computer Aided Manufg; Computer Integrated Manufg
16.30.02	Factory Automation; Cell Controller Software
16.30.03	Manufacturing Execution Software (MES)
16.30.04	Production Control software
16.30.05	Test Programs
16.30.06	Yield Mgmt; Process Control Software
16.31	Simulation, Analysis; Modeling Software
16.31.01	Mask Making software & simulation
16.31.02	Simulation; Characterization; Verification Software
16.31.03	Statistical Analysis; Modeling; Cost of Ownership (CoO) Software
16.32	Manufacturing Services
16.32.01	Building Maintenance

16.32.02	Burn-In Service
16.32.03	Calibration & Reference Standards
16.32.04	Certification; Compliance; Independent Laboratories
16.32.05	Deposition Service
16.32.06	Etch; Strip; Cleaning Service
16.32.07	Failure Analysis and other Analytical Services
16.32.08	Ion Implant Service
16.32.09	Lithography; Patterning service
16.32.10	Machine Shop; Fabrication Service
16.32.11	Measurement; Inspection Service
16.32.12	Micro Machining services (small hole drilling and milling)
16.32.13	Parts Cleaning; Micro Contamination
16.32.14	Plating; Electro Polishing; Coating; Surface Treatment
16.32.15	Reclaim Services
16.32.16	Repair; Rebuild; Install Equipment; Maintenance Services; Spare Parts
16.32.17	Sawing; Lapping; Grinding; Polishing Service
16.32.18	Used; Rental Equipment; Inventory Reduction, Appraisal - Brokers; Resellers
16.32.19	Wafer Bumping Service
16.32.20	Welding; specialty welding services
16.33	Manufacturing Services or Consulting
16.33.01	Assembly
16.33.02	Automation & Robotics
16.33.03	CAD; CAM; CIM
16.33.04	Circuit Design; Electronic Design Services (EDS); System Level Design (SLD)
16.33.05	Clean Room; Contamination Control
16.33.06	Environmental, Health & Safety
16.33.07	Equipment; Hardware; Product Design, Integration and Manufacturing
16.33.08	Facilities; Building Environmental Systems Design & Monitoring; Alternative Energy Solutions
16.33.09	Facility Design; Construction; Architectural
16.33.10	Factory; Industrial Control; Utilization & Automation
16.33.11	Flat Panel Display (FPD) Design & Manufacturing
16.33.12	Manufacturing Process Support and Development
16.33.13	Nanotechnology Intellectual Property Development; Research
16.33.14	Package Materials; Interconnect; Subcomponent; Subassembly Design Services
16.33.15	Package Simulation; Characterization Services
16.33.16	Product Development; Software Design; Product Lifecycle Management
16.33.17	Software Programming; Software Development
16.33.18	Static; ESD Testing & Control Services
16.33.19	Technical Intelligence; Reverse Engineering
16.33.20	Test Services or Consulting
16.33.21	Wafer Fab Operations and Design
16.33.22	Wafer Handling
16.33.23	Waste Control; Disposal Design
16.34	Associations
16.34.01	Associations; Trade or Industrial
16.34.02	Professional Societies
16.35	Distribution and Logistics
16.35.01	Crating; Packaging
16.35.02	Customs Clearance; Import/ Export; Freight Forwarders
16.35.03	Distribution, Warehousing, 3rd Party Logistics Providers (3PL)
16.35.04	Transportation; Rigging
16.36	Educational; Research Institutions

16.36.01	Education; Research Institutions (For-Profit); Vocational Training
16.36.02	Education; Research Institutions (Non Profit); Academia; Schools
16.37	Financial Services
16.37.01	Financial; Auditing; Tax Services
16.37.02	Investor Relations
16.37.03	Venture Capital
16.38	Professional Services
16.38.01	Government Advocacy; Regulation; Economic Development Agencies
16.38.02	IT; Data Processing Services
16.38.03	Market Studies; Market Research Organizations
16.38.04	Marketing or Sales Consultants
16.38.05	Operations; Management Consulting
16.38.06	Personnel Services; Employee Assistance; Recruiters; HR
16.38.07	Property Management; Real Estate
16.38.08	Public Relations
16.38.09	Purchasing; Procurement; Materials; Supply Chain Management Services
16.38.10	Sales; Manufacturers Representation or Distributors
16.38.11	Trade Shows; Conference; Symposium Coordinators
16.39	PV Services
16.39.01	Education, Training
16.39.02	Financing, Promotion
16.39.03	Organization, Association
16.39.04	Research and Development
16.39.05	Testing Institutes
16.40	Support Products
16.40.01	Analytical Standards; Calibrators
16.40.02	Clean Room Supplies; Cleaning Supplies
16.40.03	Device; Wafer; Display Panel Handling Products
16.40.04	Furniture; Storage; Cabinets
16.40.05	Laboratory Apparatus and Supplies
16.40.06	Safety
16.40.07	Tools
16.41	Printed, Organic, Flexible and Large Area
16.41.01	Device Manufacturing: Batteries
16.41.02	Device Manufacturing: Display
16.41.03	Device Manufacturing: Electronic
16.41.04	Device Manufacturing: Integrated systems
16.41.05	Device Manufacturing: Lighting
16.41.06	Device Manufacturing: Photovoltaic
16.41.07	Device Manufacturing: RFID
16.41.08	Device Manufacturing: Semiconductor
16.41.09	Device Manufacturing: Sensors
16.41.10	Device Manufacturing: Wearable electronics
16.41.11	Equipment: Clean room
16.41.12	Equipment: Curing
16.41.13	Equipment: Inspection
16.41.14	Equipment: laboratory
16.41.15	Equipment: Material Handling
16.41.16	Equipment: Printing, coating
16.41.17	Equipment: Process integration & control
16.41.18	Equipment: Roll to roll
16.41.19	Equipment: Systems
16.41.20	Equipment: Vacuum deposition
16.41.21	Materials: Consumables
16.41.22	Materials: Gases and Liquid Chemicals

16.41.23	Materials: Inks, pastes, printing
16.41.24	Materials: Inorganic
16.41.25	Materials: Organic
16.41.26	Materials: Other
16.41.27	Materials: Substrates, encapsulation, packaging
16.41.28	Services: Education, Training
16.41.29	Services: Research and Development
16.41.30	Services: Testing Institutes
16.42	Other
16.42.01	Other
16.43	Electronic Components
16.43.01	Components: Low Power Electronics
16.43.02	Components: ASIC's
16.43.03	Components: Flexible Electronics
16.43.04	Components: IC's
16.43.05	Components: IDM / Foundries
16.43.06	Components: MEMS
16.43.07	Components: Sensors
16.43.08	Design: CAD Tools
16.43.09	Design: Design House
16.43.10	Design: Fabless
16.43.11	Design: IP vendors
16.43.12	Design: Modelling
16.44	Electronic Applications
16.44.01	Energy Efficiency: Energy Harvesting Solutions
16.44.02	Energy Efficiency: High voltage solutions
16.44.03	Energy Efficiency: Low Power Electronics
16.44.04	Energy Efficiency: Power electronics
16.44.05	Energy Efficiency: Power Supplies and Batteries
16.44.06	Healthcare: Device Implants
16.44.07	Healthcare: Flexible Intelligent Devices
16.44.08	Healthcare: sensors
16.44.09	Imaging: Camera and Camera Modules
16.44.10	Imaging: CCD, CMOS and organic sensors
16.44.11	Imaging: Image Processing, Software and System
16.44.12	Imaging: Optics and Micromechanic
16.44.13	Lighting: LED
16.44.14	Lighting: OLED
16.44.15	Lighting: PLED
16.44.16	Security: Biometrics
16.44.17	Security: Identification
16.44.18	Security: Tracking, e-ticketing